




**SPECIFICATION SHEET**

<b>SPECIFICATION SHEET NO.</b>	Q1108-BZT52C5V61S0W9	
<b>DATE</b>	Nov. 08, 2023	
<b>REVISION</b>	A0	Updated With Most Recent Data - Official First Release
<b>DESCRIPTION AND MAIN PARAMETRICS</b>	<p>SMD Zener Diodes, BZT52C series, Case SOD-123            BZT52C5V6 Type, 2 Pads            Voltage - Zener (Nom.) (Vz): 5.6V, Peak Pulse Power: 500 mW            Operating Temp. Range -65°C ~+150°C            Package in Tape/Reel, 3000pcs/Reel            RoHS III/REACH Compliant and Halogen Free (HF)</p>	
<b>CUSTOMER</b>		
<b>CUSTOMER PART NO.</b>		
<b>CROSS REF. PART NO.</b>		
<b>ORIGINAL MFG/PART NO.</b>	MDD/BZT52C5V6	
<b>PART CODE</b>	BZT52C5V61S0W9	

<b>VENDOR APPROVE</b>
Issued/Checked/Approved <div style="display: flex; justify-content: space-around; margin-top: 10px;">    </div>
DATE: Nov. 08, 2023

<b>CUSTOMER APPROVE</b>
DATE:

**SMD ZENER DIODES BZT52C SERIES CASE SOD-123**

**MAIN FEATURE**

- Small Signal Zener Diodes
- SOD-123 Plastic-Encapsulate Diodes
- Total power dissipation: Max. 500mW.
- Planar die construction
- General purpose and medium current
- Wide Zener reverse voltage range 2.0V to 75V.
- Small plastic package suitable for surface mounted design.
- Tolerance approximately  $\pm 5\%$
- REACH/RoHS III Complaint and Halogen Free
- Cross Main Competitor Parts in Market



**APPLICATION**

- For SMD application

**RFQ**

[Request For Quotation](#)

**PART CODE GUIDE**

BZT52C	5V61	S	0W9
1	2	3	4

1. BZT52C: SMD Zener Diodes, BZT52C series Code
2. 5V61: Specification code for Voltage - Zener (Nom) (Vz): 5.6V, Package Case SOD-123
3. S: Package code, Tape/Reel
4. 0W9: Marking code for “W9” on the case surface, Different Marking for different specification

**ELECTRICAL CHARACTERISTICS**

See Page 5 ~ Page 6 For Different Part Code

**HOW TO ORDER**

Please indicate part code and send us your RFQ by E-mail, [sales@nextgencomponent.com](mailto:sales@nextgencomponent.com)

**SMD ZENER DIODES BZT52C SERIES CASE SOD-123**

**DIMENSION** - Unit: Inch/mm

Image for reference

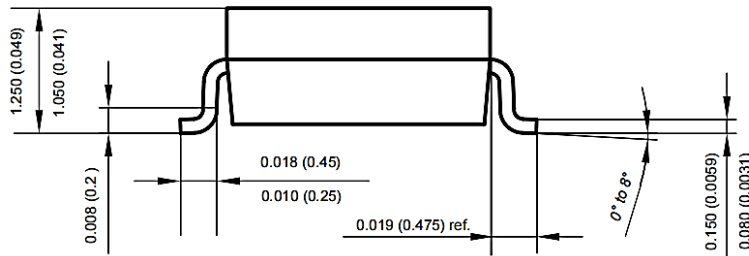
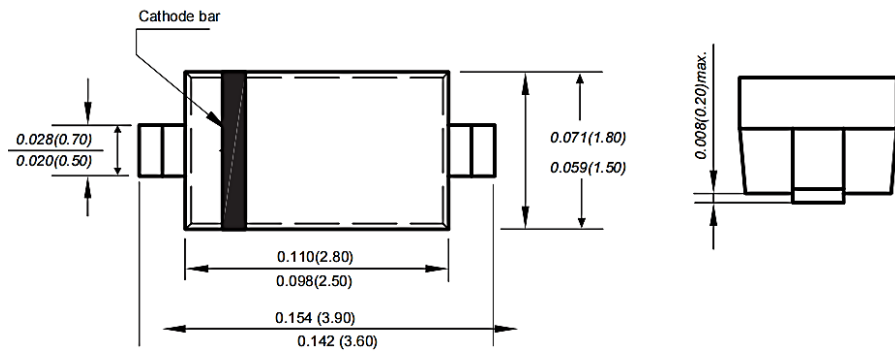


**Marking:** Standard

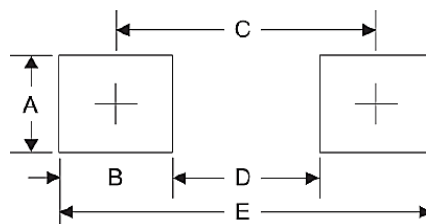
\* See Marking Code List at

Page 5~ Page 6

**Case Dimension:**  
SOD-123



**Recommend Pad Layout**



Symbol	Unit (Inch)	Unit (mm)
A	0.047	1.20
B	0.047	1.20
C	0.126	3.20
D	0.079	2.00
E	0.173	4.40

**SMD ZENER DIODES BZT52C SERIES CASE SOD-123**

**MECHANICAL DATA**

Case	Terminals	Polarity	Mounting Position	Marking	Weight per piece
JEDEC SOD-123 molded plastic body	Solderable per MIL-STD-750, Method 2026	Polarity symbol marking on body	ANY	See Marking Code List (Page 5~Page 6)	0.00056 ounce 0.0016 grams

**MAX. RATING & CHARACTERISTICS** - Ratings at 25°C Ambient Temperature Unless Otherwise Specified.

Parameter	SYMBOLS	VALUE	UNITS
Forward Voltage @ I <sub>F</sub> =10mA (Note 2)	V <sub>F</sub>	0.9	V
Peak Pulse Power Dissipation	P <sub>D</sub>	500	mW
Typical Thermal Resistance From Junction To Ambient (Note 1)	R <sub>θJA</sub>	305	°C/W
Operating Junction Temperature Range	T <sub>J</sub>	-65 ~ +150	°C
Storage Temperature Range	T <sub>stg</sub>	-65 ~ +150	°C

Notes

1. Thermal Resistance From Junction To Ambient at P.C.B. Mounted With 2.0" X 2.0" (5 X 5 cm) Copper Areas Pads.

**SMD ZENER DIODES BZT52C SERIES CASE SOD-123**
**ELECTRICAL CHARACTERISTICS UNIDIRECTIONAL TYPE - Ta = 25°C**

Part Code	Zener Voltage Range (See Note 1) V <sub>ZT</sub> @ I <sub>ZT</sub> (V)			Test Current I <sub>ZT</sub> (mA)	Dynamic Impedance Max. Z <sub>ZT</sub> @ I <sub>ZT</sub> (Ω)	Reverse Current		Marking Code
	Min.	Nom	Max.			Max. I <sub>R</sub> (μA)	@ V <sub>R</sub> (V)	
BZT52C2V01S0WY	1.8	2	2.15	5	100	120	0.5	WY
BZT52C2V21S0WZ	2.08	2.2	2.33	5	100	120	0.7	WZ
BZT52C2V41S0WX	2.28	2.4	2.56	5	100	120	1	WX
BZT52C2V71S0W1	2.5	2.7	2.9	5	110	120	1	W1
BZT52C3V01S0W2	2.8	3	3.2	5	120	50	1	W2
BZT52C3V31S0W3	3.1	3.3	3.5	5	130	20	1	W3
BZT52C3V61S0W4	3.4	3.6	3.8	5	130	10	1	W4
BZT52C3V91S0W5	3.7	3.9	4.1	5	130	5	1	W5
BZT52C4V31S0W6	4	4.3	4.6	5	130	5	1	W6
BZT52C4V71S0W7	4.4	4.7	5	5	130	2	1	W7
BZT52C5V11S0W8	4.8	5.1	5.4	5	130	2	1.5	W8
<b>BZT52C5V61S0W9</b>	<b>5.2</b>	<b>5.6</b>	<b>6</b>	<b>5</b>	<b>80</b>	<b>1</b>	<b>2.5</b>	<b>W9</b>
BZT52C6V21S0WA	5.8	6.2	6.6	5	50	1	3	WA
BZT52C6V81S0WB	6.4	6.8	7.2	5	30	0.5	3.5	WB
BZT52C7V51S0WC	7	7.5	7.9	5	30	0.5	4	WC
BZT52C8V21S0WD	7.7	8.2	8.7	5	30	0.5	5	WD
BZT52C9V11S0WE	8.5	9.1	9.6	5	30	0.5	6	WE
BZT52C101S00WF	9.4	10	10.6	5	30	0.1	7	WF
BZT52C111S00WG	10.4	11	11.6	5	30	0.1	8	WG
BZT52C121S00WH	11.4	12	12.7	5	35	0.1	9	WH
BZT52C131S00WI	12.4	13	14.1	5	35	0.1	10	WI

**SMD ZENER DIODES BZT52C SERIES CASE SOD-123**
**ELECTRICAL CHARACTERISTICS UNIDIRECTIONAL TYPE - Ta = 25°C**

Part Code	Zener Voltage Range (See Note 1) V <sub>ZT</sub> @ I <sub>ZT</sub> (V)			Test Current I <sub>ZT</sub> (mA)	Dynamic Impedance Max. Z <sub>DT</sub> @ I <sub>ZT</sub> (Ω)	Reverse Current		Marking Code
	Min.	Nom	Max.			Max. I <sub>R</sub> (μA)	@ V <sub>R</sub> (V)	
BZT52C151S00WJ	13.8	15	15.6	5	40	0.1	11	WJ
BZT52C161S00WK	15.3	16	17.1	5	40	0.1	12	WK
BZT52C181S00WL	16.8	18	19.1	5	45	0.1	13	WL
BZT52C201S00WM	18.8	20	21.2	5	50	0.1	15	WM
BZT52C221S00WN	20.8	22	23.3	5	55	0.1	17	WN
BZT52C241S00WO	22.8	24	25.6	5	60	0.1	19	WO
BZT52C271S00WP	25.1	27	28.9	5	70	0.1	21	WP
BZT52C301S00WQ	28	30	32	5	80	0.1	23	WQ
BZT52C331S00WR	31	33	35	5	80	0.1	25	WR
BZT52C361S00WS	34	36	38	5	90	0.1	27	WS
BZT52C391S00WT	37	39	41	2.5	100	2.0	30	WT
BZT52C431S00WU	40	43	46	2.5	130	2.0	33	WU
BZT52C471S00WV	44	47	50	2.5	150	2.0	36	WV
BZT52C511S00WW	48	51	54	2.5	180	1.0	39	WW
BZT52C561S00XW	52	56	60	2.5	180	1.0	43	XW
BZT52C621S006E	58	62	66	2.5	200	0.2	47	6E
BZT52C681S006F	64	68	72	2.5	250	0.2	52	6F
BZT52C751S006H	70	75	79	2.5	300	0.2	57	6H

Notes 1: V<sub>ZT</sub> is tested with pulses (20 ms)

**SMD ZENER DIODES BZT52C SERIES CASE SOD-123**

**RATINGS AND CHARACTERISTIC CURVES** (For Reference Only) -  $T_a = 25^\circ\text{C}$  Unless Otherwise Specified

Figure 1. Maximum Continuous Power Derating Curve

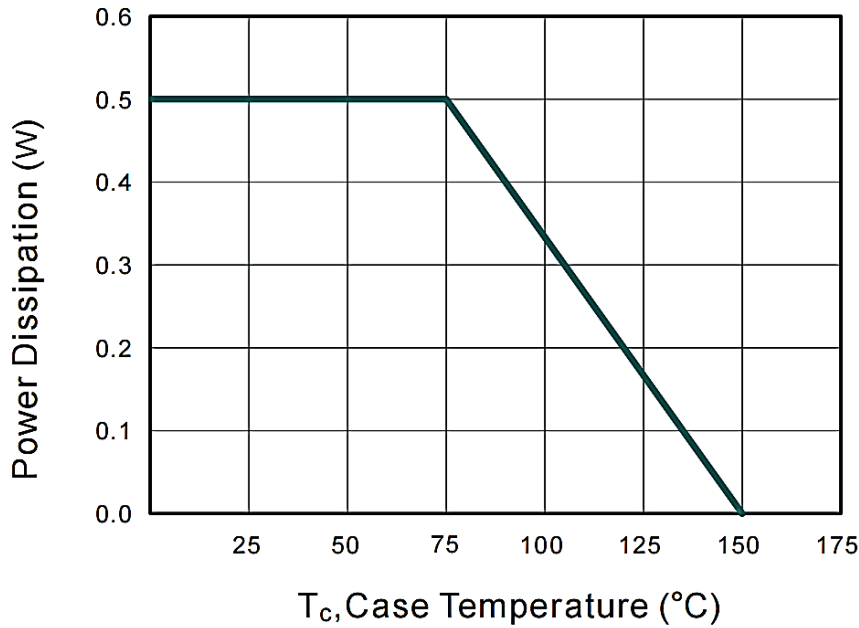
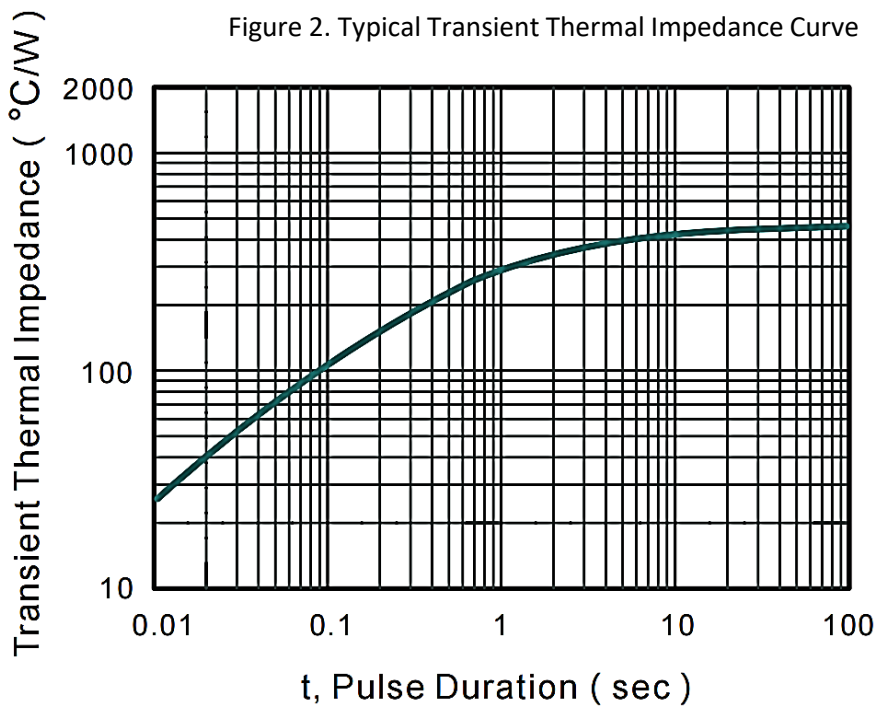


Figure 2. Typical Transient Thermal Impedance Curve



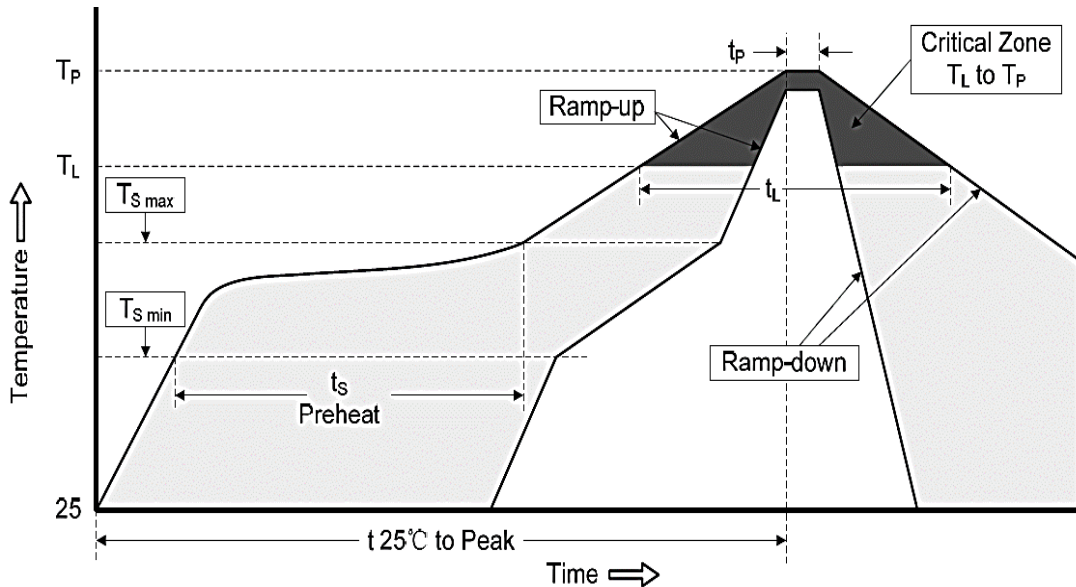
**SMD ZENER DIODES BZT52C SERIES CASE SOD-123**
**RELIABILITY**

Number	Experiment Items	Experiment Method And Conditions	Reference Documents
1	Solder Resistance Test	Test 260°C± 5°C for 10 ± 2 sec. Immerse body into solder 1/16" ± 1/32"	MIL-STD-750D METHOD-2031.2
2	Solderability Test	230°C ±5°C for 5 sec.	MIL-STD-750D METHOD-2026.1 0
3	Pull Test	1 kg in axial lead direction for 10 sec.	MIL-STD-750D METHOD-2036.4
4	Bend Test	0.5Kg Weight Applied To Each Lead, Bending Arcs 90 °C ± 5 °C For 3 Times	MIL-STD-750D METHOD-2036.4
5	High Temperature Reverse Bias Test	TA=100°C for 1000 Hours at VR=80% Rated VR	MIL-STD-750D METHOD-1038.4
6	Forward Operation Life Test	TA=25°C Rated Average Rectified Current	MIL-STD-750D METHOD-1027.3
7	Intermittent Operation Life Test	On state: 5 min with rated IRMS Power Off state: 5 min with Cool Forced Air. On and off for 1000 cycles.	MIL-STD-750D METHOD-1036.3
8	Pressure Cooker Test	15 PSIG, TA=121°C, 4 hours	MIL-S-19500 APPENOIXC
9	Temperature Cycling Test	-55°C~+125°C; 30 Minutes For Dwelled Time 5 minutes for transferred time. Total: 10 cycles.	MIL-STD-750D METHOD-1051.7
10	Thermal Shock Test	0°C for 5 minutes., 100°C for 5minutes, Total: 10 cycles	MIL-STD-750D METHOD-1056.7
11	Forward Surge Test	8.3ms Single Sale Sine-wave One Surge.	MIL-STD-750D METHOD-4066.4
12	Humidity Test	TA=65°C, RH=98% for 1000 hours.	MIL-STD-750D METHOD-1021.3
13	High Temperature Storage life Test	150°C for 1000 Hours	MIL-STD-750D METHOD-1031.5



**SMD ZENER DIODES BZT52C SERIES CASE SOD-123**

**SUGGESTED REFLOW PROFILE - For Reference Only**



Profile Feature		Pb-Free Assembly
Average Ramp-up Rate (Ts Max to Tp)		3°C/second Max
Preheat	Temperature Min (Ts Min.)	150°C
	Temperature Max (Ts Max.)	200°C
	Time (ts Min. to ts Max.)	60 ~ 180 seconds
Time maintained above	Temperature ( $T_L$ )	217°C
	Time ( $t_L$ )	60 ~ 150 seconds
Peak/Classification Temperature ( $T_P$ )		260 °C
Time within 5°C of actual Peak Temperature ( $t_p$ )		20 ~ 40 seconds
Ramp-down rate		6 °C /Second Max.
Time 25 °C to Peak Temperature		8 minutes Max.
Suggest reflow times		3 Times Max.

**SMD ZENER DIODES BZT52C SERIES CASE SOD-123**

**TAPE/REEL, 3000pcs/Reel** (Unit: mm)

All Devices are packed in accordance with EIA standard RS-481-A and Tape wide 8mm, Component Spacing 4.0mm



Item	Symbol	Tolerance	Case SOD-123
Carrier width	A	0.1	2.10
Carrier Length	B	0.1	4.00
Carrier Depth	C	0.1	1.60
Sprocket hole	d	0.05	1.55
13"Reel outside diameter	-	-	-
13"Reel inner diameter	-	-	-
7"Reel outside diameter	D	2.0	178.00
7"Reel inner diameter	D1	Min.	50.00
Feed hole diameter	D2	0.5	13.00
Sprocket hole position	E	0.1	1.75
Punch hole position	F	0.1	3.50
Punch hole pitch	P	0.1	4.00
Sprocket hole pitch	P0	0.1	4.00
Embossment center	P1	0.1	2.00
Overall tape thickness	T	0.1	0.25
Tape width	W	0.3	8.15
Reel width	W1	1.0	10.50

## SMD ZENER DIODES BZT52C SERIES CASE SOD-123

### ROHS COMPLIANCE

- The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU RoHS Directive (EU) 2015/863 EC (RoHS3). RoHS Test Report for this product can be obtained can be obtained at Download Center.

### REACH COMPLIANCE

- REACH substances of high concern (SVHCs) information is available for this product. Since the European Chemical Agency (ECHA) has published notice of their intent to frequently revise the SVHC listing for the foreseeable future, REACH Test Report for this product can be obtained can be obtained at Download Center.

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